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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

APPLICANT: Bradley Dale Mitchell

SERIAL NO.: 09/943,569

FILING DATE: August 30, 2001

TITLE: System and Method for Removing Deposited Material from Within a Semiconductor Fabrication Device

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ART UNIT: 1746

#10

CERTIFICATE OF MAILING

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Beatrice Orozco

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TRANSMITTAL FOR FORMAL DRAWINGS

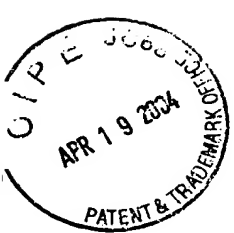
With respect to the above-identified patent application, enclosed herewith for filing are five (5) sheets of Formal Drawings.

Respectfully submitted
THELEN REID & PRIEST LLP

Dated: April 15, 2004

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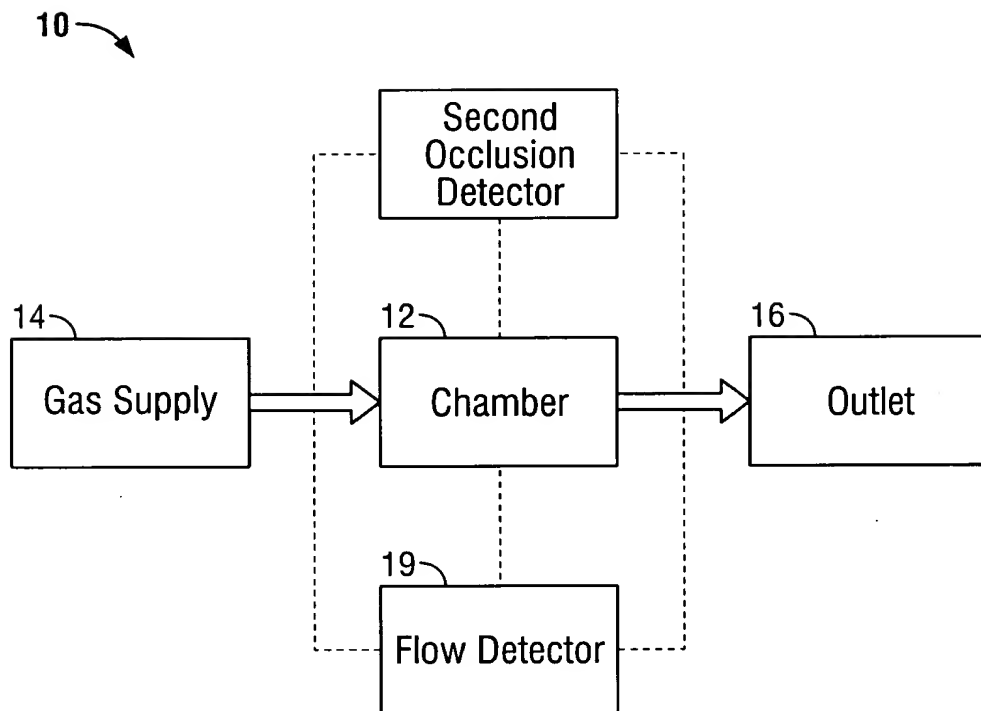
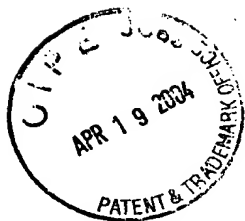


FIG. 1



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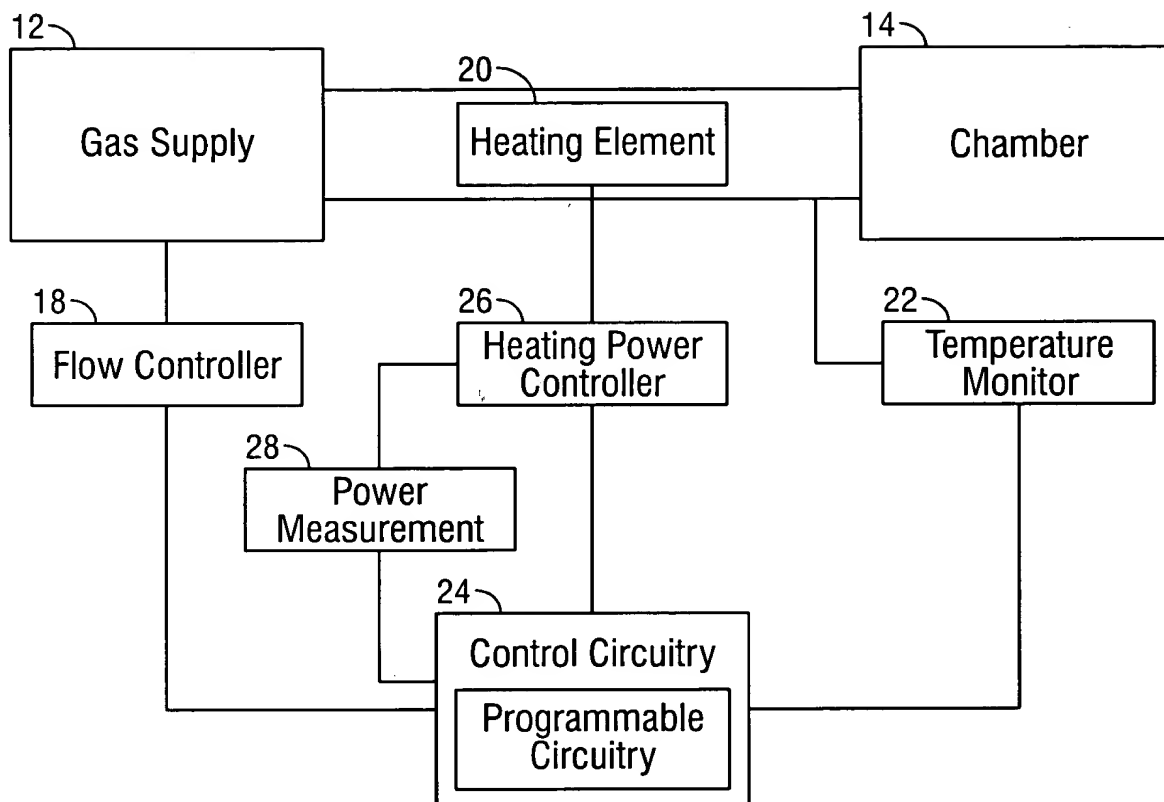


FIG. 2

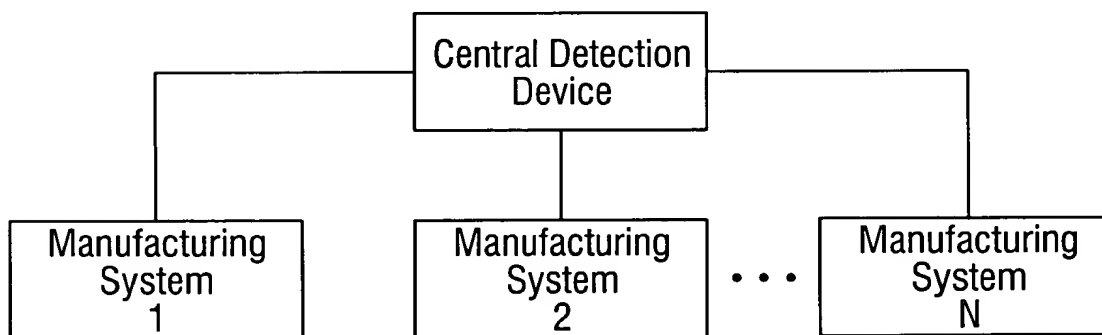
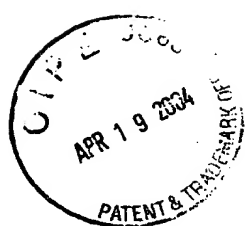


FIG. 3



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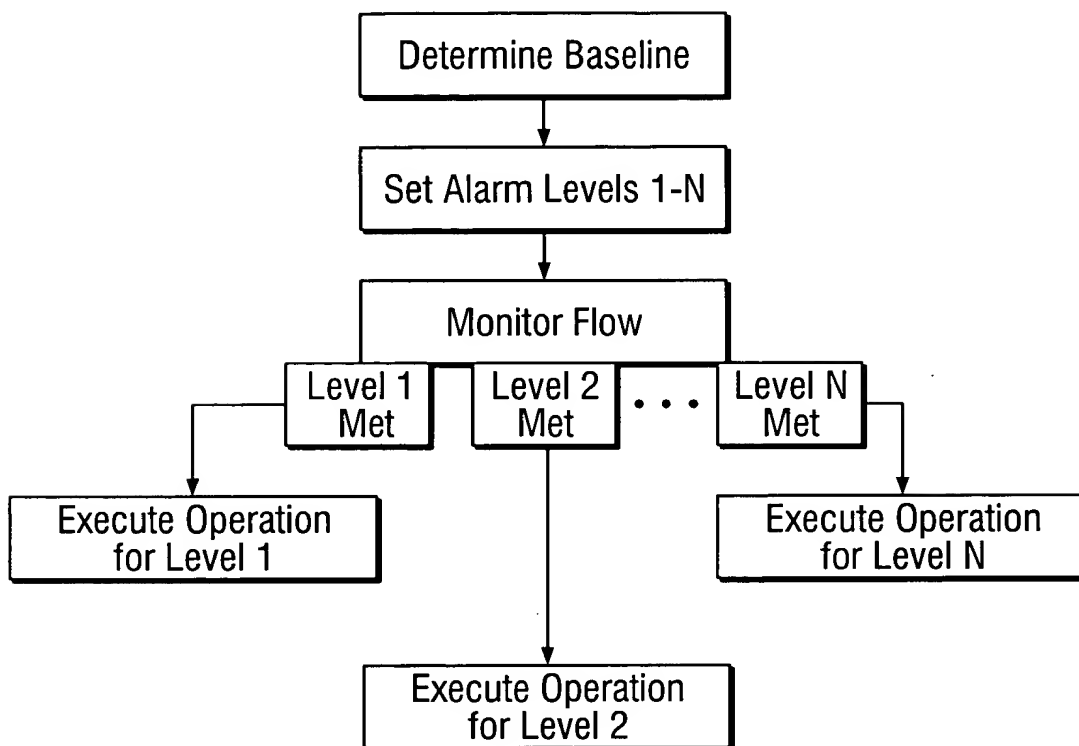


FIG. 4

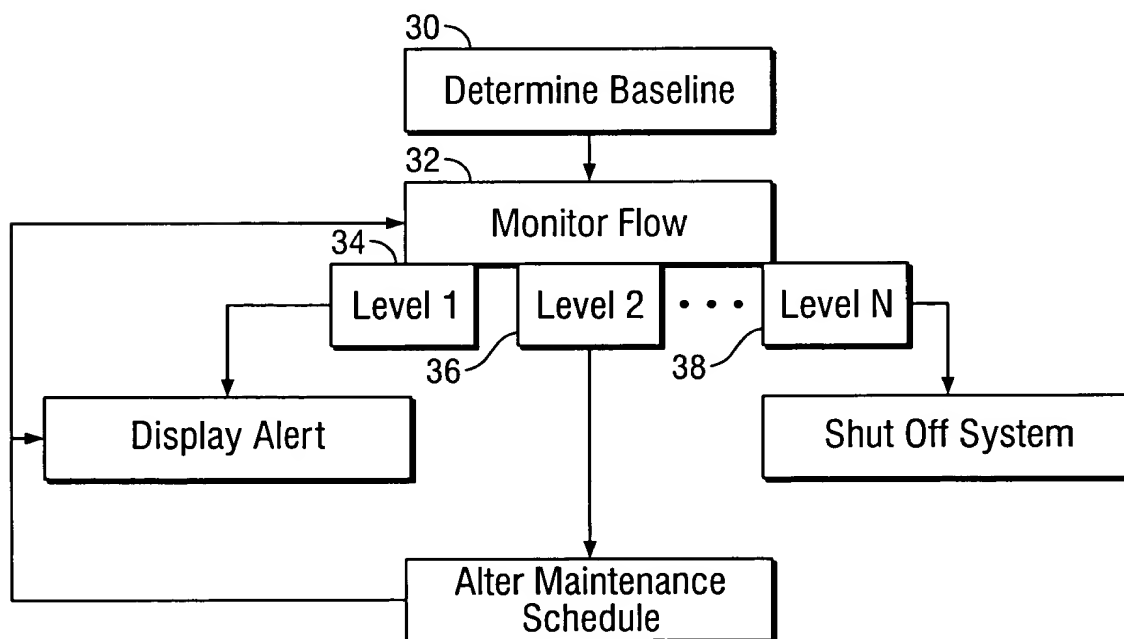
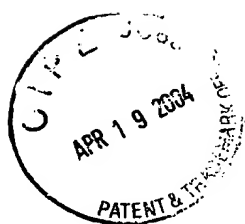


FIG. 5



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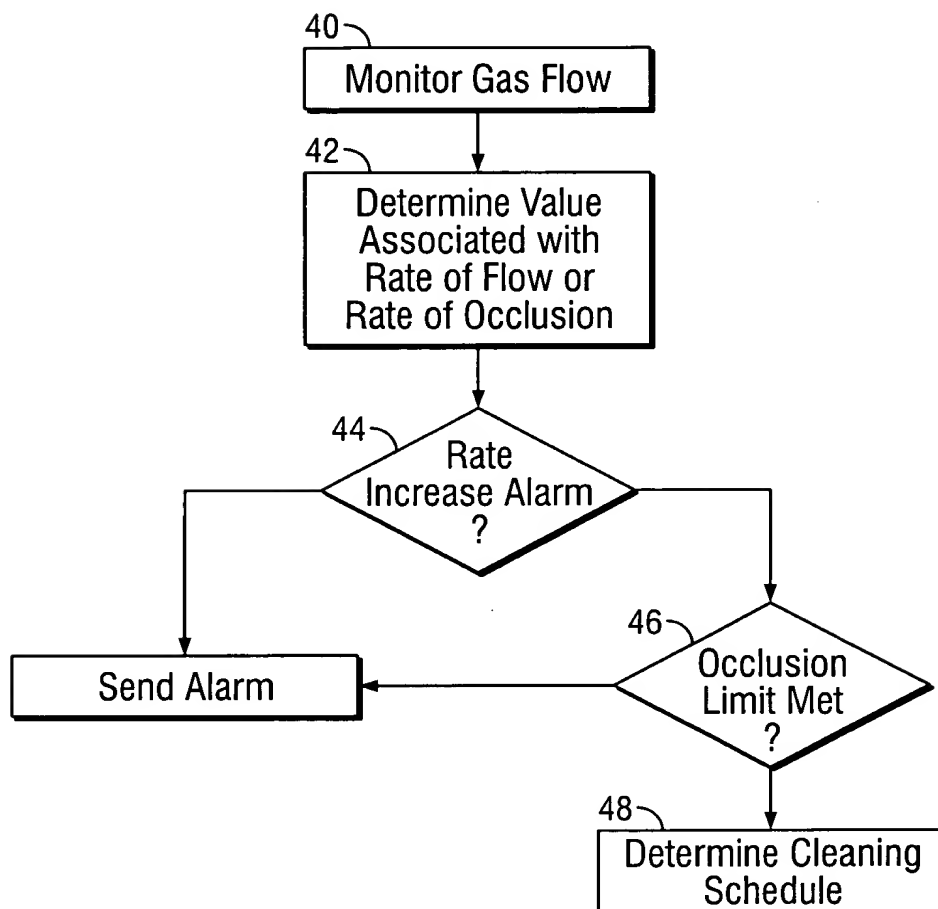


FIG. 6

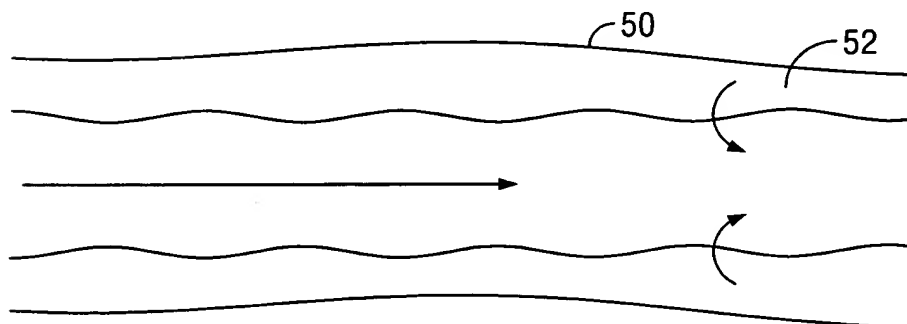
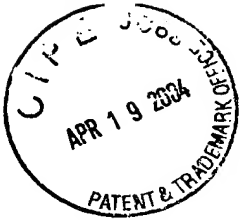


FIG. 7



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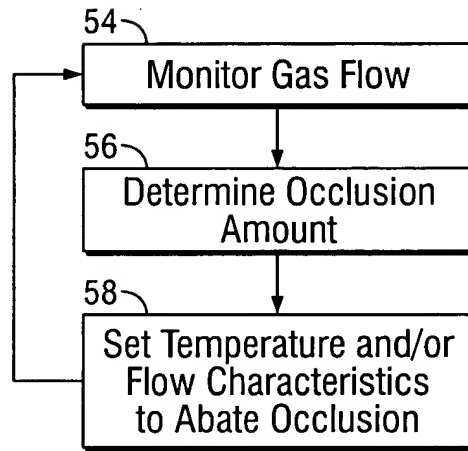


FIG. 8

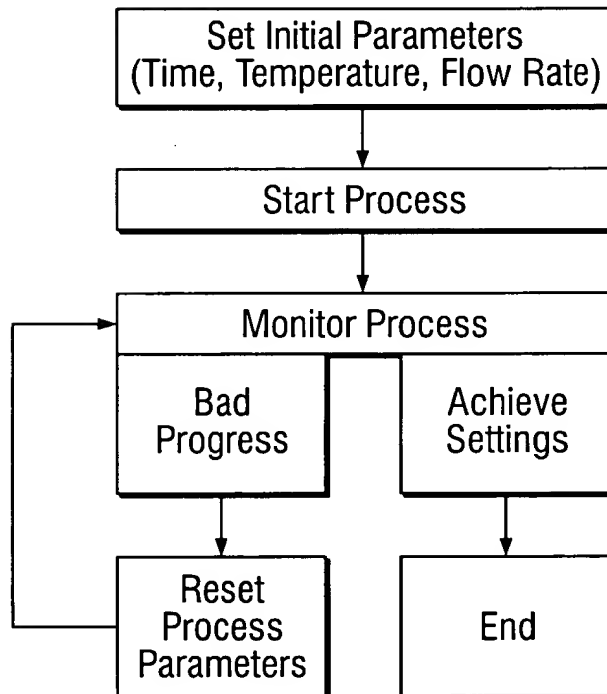


FIG. 9